Spec. No.: RMPC-K-HTS-0001 /2 Date: 2017.1.10
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CHIP RESISTORS; AND Pb<100ppm
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Барара Карана Карана AMAAYA ELECTRIC CO., LTD. Hokkaido Research Center Approval by: T. Sannomiya Drawing by: M. Shibuya

Drawing No: RMPC-K-HTS-0001 /2

Style

FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE AND Pb<100ppm Title: RMPC04,06,10,16,20,32,35

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1. Scope

1.1 This specification covers the detail requirements for fixed thick film chip resistors; rectangular type, style of RMPC04, 06, 10, 16, 20, 32, 35.

1.2 Applicable documents

JIS C 5201-1: 2011, JIS C 5201-8: 2014, JIS C 5201-8-1: 2014 IEC60115-1: 2008, IEC60115-8: 2009, IEC60115-8-1: 2014 EIAJ RC-2134C-2010

2. Classification

(Example)

Type designation shall be the following form.

		0				
1)	RMPC	16		123	J	TP
	1	2	3	4	5	6
	Style	e				
2)	RMPC	16		JP		TP
	1	2		4		6
	Style	е				

1 Fixed thick film chip resistors; rectangular type & Pb<100ppm

2 Dimension

3 Temperature coefficient of resistance

-(Dash) Standard

4 Rated resistance

123	E24 Series, 3 digit,	Ex. 123> 12kΩ,
1000	E96 Series, 4 digit,	Ex. 1000>100Ω
		1022> 10.2kΩ
JP	Chip jumper	

5 Tolerance on rated resistance

F	±1%
J	±5%

6 Packaging form

В	Bulk (loose package)		
PA	Press pocket taping		
TH	Denertening		
TP	Paper taping		
TE	Embossed taping		

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3. Rating

3.1 The ratings shall be in accordance with Table-1.

	Rated	Tomporati	Table-1		Preferred	
Style	dissipation (W)	Temperature coefficient of resistance (10 ⁻⁶ /°C)		Rated resistance range (Ω)	number series for resistors	Tolerance on rated resistance
			±200	100~1M	E24 E06	E(±10/)
RMPC04	0.03	Standard	+600~0	10~97.6k	E24, E96	F(±1%)
KIVIF C04	0.03	Stanuaru	±200	10k~1M	E24	
			+600~0	10~9.1k	E24	J(±5%)
			±200	100~1M		
			+600~0	10~97.6	E24, 96	F(±1%)
RMPC06	0.05	Standard	+800~-100	1~9.76		
RIVIPCUO	0.05	Standard	±200	100~10M		
			+600~0	10~91	E24	J(±5%)
			+800~-100	1~9.1		
			±200	100~1M		
			+500~-200	10~97.6	E24, 96	F(±1%)
	0.000	Oteraterat	+800~-100	1~9.76		· · · · ·
RMPC10	0.063	Standard	±200	100~10M		J(±5%)
			+600~0	10~91	E24	
			+800~-100	1~9.1		
		0.1 Standard	±200	100~1M	E24, 96	F(±1%) J(±5%)
			+500~-200	10~97.6		
			+800~-100	1~9.76		
RMPC16	0.1		±200	100~10M		
			+600~0	10~91	E24	
			+800~-100	1~9.1		
			±200	100~1M	E24, 96	F(±1%)
			+500~-200	10~97.6		
	0.405	Oteraterat	+800~-100	1~9.76		
RMPC20	0.125	Standard	±200	100~10M		
			+600~0	10~91	E24	J(±5%)
			+800~-100	1~9.1		
			±200	100~1M		
			+500~-200	10~97.6	E24, 96	F(±1%)
	0.05	Oteraterat	+800~-100	1~9.76		. (,0)
RMPC32	0.25	Standard	±200	100~10M		
			+600~0	10~91	E24	J(±5%)
			+800~-100	1~9.1		\``´`
	±200 100~1M					
			+500~-200	10~97.6	E24, 96	F(±1%)
	0.00		+800~100	1~9.76	· · ·	
RMPC35	0.33	Standard	±200	100~10M	E24	
			+600~0	10~91		J(±5%)
			+800~-100	1~9.1		-(

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		Ta	ble-1(2)
Style	Limiting element voltage (V)	Isolation voltage (V)	Category temperature range (°C)
RMPC04	15	50	
RMPC06	25	50	
RMPC10	100	100	
RMPC16	100	100	-55~+125
RMPC20	150		
RMPC32	200	500	
RMPC35	200		

Note. Rated current of chip jumper: RMPC04: 0.5(A), RMPC06,10: 1(A), RMPC16,20,32,35: 2(A) Note. Resistance value of chip jumper: 50 m Ω max.

3.2 Climatic category

55/125/56	Lower category temperature	−55 °C
	Upper category temperature	+125 °C
	Duration of the damp heat, steady state test	56days

3.3 Stability class

5%

Limits for change of resistance:				
-for long-term tests	±(5%+0.1Ω)	Chip jumper: 50 m Ω max.		
-for short-term tests	±(1%+0.05Ω)	Chip jumper: 50 m Ω max.		

3.4 Derating

The derated values of dissipation (or current rating in case of chip jumper) at temperature in excess of 70 °C shall be as indicated by the following curve.

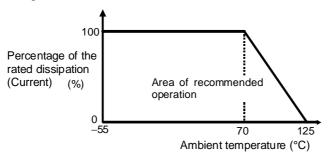


Figure-1 Derating curve

3.5 Rated voltage

d. c. or a. c. r. m. s. voltage calculated from the square root of the product of the rated resistance and the rated dissipation.

 $E = \sqrt{P \cdot R}$

E : Rated voltage (V) P : Rated dissipation (W) R : Rated resistance (Ω)

Limiting element voltage can only be applied to resistors when the resistance value is equal to or higher than the critical resistance value.

At high value of resistance, the rated voltage may not be applicable.

If you have any questions or a Purchasing Specification for any quality agreement is necessary, please contact our sales staff.

Issue: KAMAYA ELECTRIC CO., LTD. Research & Development Department HOKKAIDO Research center Last update: 2017.1.10

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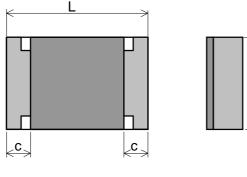
4. Packaging form

The standard packaging form shall be in accordance with Table-2.

		Table-2		
Symbol	Packaging form		Standard packaging quantity / units	Application
В	Bulk (loose package)		1,000 pcs.	RMPC04,06,10,16,20,32,35
PA	Press pocket taping	8mm width, 2mm pitches	20,000 pcs.	RMPC04
PA (paper taping)		(paper taping)	15,000 pcs.	RMPC06
TH	Paper taping	8mm width, 2mm pitches	10,000 pcs.	RMPC10
TP	Paper taping	8mm width, 4mm pitches	5,000 pcs.	RMPC16,20,32
TE	Embossed taping	8mm width, 4mm pitches	4,000 pcs.	RMPC35

5. Dimensions

5.1 The resistor shall be of the design and physical dimensions in accordance with Figure-2 and Table-3.



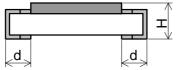


Figure-2

≥

		Table-3		U	nit : mm
Style	L	W	Н	С	d
RMPC04	0.4±0.02	0.2 <u>+</u> 0.02	0.13±0.02	0.08±0.03	0.1±0.03
RMPC06	0.6 <u>±</u> 0.03	0.3 <u>+</u> 0.03	0.23±0.03	0.1±0.05	0.15 <u>±</u> 0.05
RMPC10	1.0±0.05	0.5±0.05	0.35±0.05	0.2 <u>+</u> 0.1	0.25 ^{+0.05}
RMPC16	1.6±0.1	0.8 ^{+0.15}	0.45 <u>+</u> 0.10	0.3 <u>+</u> 0.1	0.3 <u>+</u> 0.1
RMPC20	2.0±0.1	1.25±0.10	0.55±0.10	0.4 <u>+</u> 0.2	0.4 <u>+</u> 0.2
RMPC32	3.1±0.1	1.6 <u>+</u> 0.15	0.55±0.10	0.5 <u>+</u> 0.25	0.5 <u>+</u> 0.25
RMPC35	3.1±0.15	2.5 <u>±</u> 0.15	0.55±0.15	0.5 <u>+</u> 0.25	0.5 <u>+</u> 0.25

5.2 Net weight (Reference)

Style	Net weight(mg)		
RMPC04	0.035		
RMPC06	0.16		
RMPC10	0.6		
RMPC16	2		
RMPC20	5		
RMPC32	9		
RMPC35	16		

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6. Marking

The Rated resistance of RMPC04,06,10 should not be marked.

6.1 RMPC16,20,32,35

The nominal resistance shall be marked in 3 digits or 4 digits and marked on over coat side.

• RMPC20,32,35: E24 series: 3 digits, E96 series: 4 digits

In case of the resistance value that E96 overlaps with E24, It is marked by either.

• The Rated resistance of RMPC16 should not be marked in 4 digits.

Marking example	Contents	Application
123	$12 \times 10^3 \ [\Omega] \rightarrow 12 \ [k\Omega]$	RMPC16,20,32,35
2R2	2.2 [Ω]	Less than 10Ω of RMPC16,20,32,35
5623	$562 \times 10^{3} [\Omega] \rightarrow 562 [k\Omega]$	RMPC20,32,35
12R7	12.7 [Ω]	RMPC20,32,.35

6.2 Marking example of Jumper Chip

Marking example	Contents	Application
0	П	RMPC16,20,32
000	JP	RMPC35

7. Performance

7.1 The standard condition for tests shall be in accordance with Sub-clause 4.2, JIS C 5201-1: 2011.

7.2 The performance shall be satisfied in Table-4.

		Table-4(1)	
No.	Test items	Condition of test (JIS C 5201–1)	Performance requirements
1	Visual examination	Sub–clause 4.4.1 Checked by visual examination.	As in 4.4.1 The marking shall be legible, as checked by visual examination.
2	Dimension	Sub-clause 4.4.2	As specified in Table–3 of this specification.
	Resistance	Sub-clause 4.5	As in 4.5.2 The resistance value shall correspond with the rated resistance taking into account the specified tolerance. Chip jumper: 50mΩ max.
3	Voltage proof	Sub-clause 4.7 Method: 4.6.1.4(See Figure-3) Test voltage: Alternating voltage with a peak value of 1.42 times the insulation voltage. Duration: 60 s ± 5 s Insulation resistance Test voltage: Insulation voltage Duration: 1 min.	No breakdown or flash over $R \ge 1 G \Omega$
4	Solderability	Sub-clause 4.17 Without ageing Flux: The resistors shall be immersed in a non-activated soldering flux for 2s. Bath temperature: 235 °C ± 5 °C Immersion time: 2 s ± 0.5 s	As in 4.17.4.5 The terminations shall be covered with a smooth and bright solder coating.

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		Table-4(2)	Performance requirements		
No		Test items Condition of test (JIS C 5201–1)			
5	Mounting	Sub–clause 4.31			
		Substrate material: Epoxide woven glass			
	Overload	Sub–clause 4.13			
	(in the mounted state)	The applied voltage shall be 2.5 times the			
		rated voltage or twice the limiting element			
		voltage, whichever is the less severe.			
		Duration: 2 s			
		Visual examination	No visible damage		
		Resistance	$\Delta R \leq \pm (1\% + 0.05\Omega)$		
			Chip jumper: $50m\Omega$ max.		
	Solvent resistance of the	Sub–clause 4.30	Legible marking		
	marking	Solvent: 2–propanol			
		Solvent temperature: $23 \degree C \pm 5 \degree C$			
		Method 1			
		Rubbing material: cotton wool			
		Without recovery			
6	Mounting	Sub-clause 4.31			
	Derived strength of the and face	Substrate material: Epoxide woven glass			
	Bound strength of the end face	Sub-clause 4.33			
	plating	Bent value: 3 mm	AB < (19(+0.050))		
		Resistance	$\Delta R \leq \pm (1\% + 0.05\Omega)$		
	Final measurements	Out aloung 4.00 C	Chip jumper: $50m\Omega$ max.		
	T indimedsulements	Sub-clause 4.33.6	No visible damage		
7	Desistance to coldering boot	Visual examination			
7	Resistance to soldering heat	Sub-clause 4.18			
		Solder temperature: 260 °C ± 5 °C			
		Immersion time: $10 \text{ s} \pm 0.5 \text{ s}$ Visual examination	As in 4.18.3.4		
		VISUALEXAMINATION	No sign of damage such as cracks.		
		Resistance	$\Delta R \le \pm (1\% + 0.05\Omega)$		
			Chip jumper: $50m\Omega$ max.		
	Component solvent resistance	Sub-clause 4.29	Unip juniper. Junisz max.		
		Solvent: 2-propanol			
		Solvent temperature: 23 °C ± 5 °C			
		Method 2			
		Recovery: 48 h			
		Visual examination	No visible damage		
		Resistance	$\Delta R \leq \pm (1\% + 0.05\Omega)$		
			Chip jumper: $50m\Omega$ max.		
L	l				

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	Table-4(3)				
No	Test items	Condition of test (JIS C 5201–1)	Performance requirements		
8	Mounting Adhesion	Sub-clause 4.31 Substrate material: Epoxide woven glass Sub-clause 4.32 Force: 3N (RMPC04: 2N, RMPC06: 3N)			
	Rapid change temperature	Duration: $10 \text{ s} \pm 1 \text{ s}$ Visual examination Sub-clause 4.19 Lower category temperature: -55 °C Upper category temperature: $+125 \text{ °C}$ Duration of exposure at each temperature: 30 min.	No visible damage		
		Number of cycles: 5 cycles. Visual examination Resistance	No visible damage $\Delta R \le \pm (1\% + 0.05\Omega)$ Chip jumper: 50m Ω max.		
9	Climatic sequence –Dry heat	Sub-clause 4.23 Sub-clause 4.23.2 Test temperature: +125 °C Duration: 16 h			
	–Damp heat, cycle (12+12hour cycle) First cycle	Sub-clause 4.23.3 Test method: 2 Test temperature: 55 °C [Severity(2)]			
	-Cold	Sub-clause 4.23.4 Test temperature -55 °C Duration: 2h			
	–Damp heat, cycle (12+12hour cycle) Remaining cycle	Sub-clause 4.23.6 Test method: 2 Test temperature: 55 °C [Severity (2)] Number of cycles: 5 cycles			
	–D.C. load	Sub-clause 4.23.7 The applied voltage shall be the rated voltage or the limiting element voltage whichever is the smaller. Duration: 1 min. Visual examination Resistance	No visible damage $\Delta R \leq \pm (5\%+0.1\Omega)$ Chip jumper: 50m Ω max.		

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	Table-4(4)					
No	Test items	Condition of test (JIS C 5201–1)	Performance requirements			
10	Mounting	Sub–clause 4.31 Substrate material: Epoxide woven glass				
	Endurance at 70 °C	Sub-clause 4.25.1 Ambient temperature: 70 °C \pm 2 °C Duration: 1000 h The voltage shall be applied in cycles of 1.5 h on and 0.5 h. The applied voltage shall be the rated voltage or the limiting element voltage whichever is the smaller. Examination at 48 h , 500 h and 1000 h: Visual examination Resistance	No visible damage $\Delta R \leq \pm (5\%+0.1\Omega)$ Chip jumper: 50m Ω max.			
11	Mounting	Sub–clause 4.31 Substrate material: Epoxide woven glass Test substrate: Figure–3				
	Variation of resistance with temperature	Sub–clause 4.8 –55 °C / +20 °C +20 °C / +125°C	As in Table-1			
12	Mounting	Sub–clause 4.31 Substrate material: Epoxide woven glass				
	Damp heat, steady state	 Sub-clause 4.24 Ambient temperature: 40 °C ± 2 °C Relative humidity : 93 ⁺²₋₃ % a) 1st group: without voltage applied. b) 2nd group: The d. c. voltage shall be applied continuously. The voltage shall be accordance with Sub-clause 4.24.2.1 b). without polarizing voltage [4.24.2.1, c)] Visual examination Resistance 	No visible damage Legible marking $\Delta R \le \pm (5\%+0.1\Omega)$ Chip jumper: 50m Ω max.			
13	Dimensions (detail) Mounting Endurance at upper category temperature	Sub-clause 4.4.3 Sub-clause 4.31 Substrate material: Epoxide woven glass TSub-clause 4.25.3 Ambient temperature: $125 \degree C \pm 2 \degree C$ Duration: 1000 h	As in Table–3			
		Examination at 48 h, 500 h and 1000 h: Visual examination Resistance	No visible damage $\Delta R \le \pm (5\%+0.1\Omega)$ Chip jumper: 50m Ω max.			

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- RMPC10,16,20,32,35

· RMPC04,06

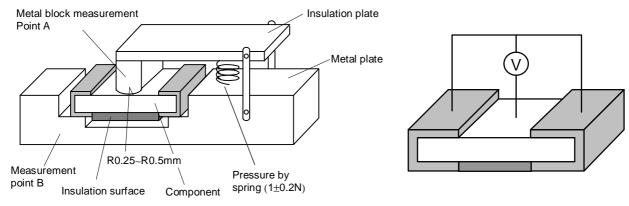


Figure-3

8. Taping

- 8.1 Applicable documents JIS C 0806-3: 2014, EIAJ ET-7200C: 2010
- 8.2 Taping dimensions
- 8.2.1 Press pocket taping (Paper taping, 8mm width, 2mm pitches) Taping dimensions shall be in accordance with Figure-4 and Table-5.

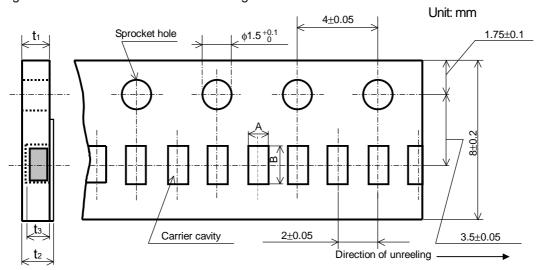


Figure-4

Table-5				Unit: mm	
Style	A	В	t 1	t ₂	t ₃
RMPC04	0.24±0.03	0.45±0.03	0.31±0.03	0.36±0.03	0.15±0.02
RMPC06	0.37 <u>±</u> 0.05	0.67 <u>±</u> 0.05	0.42 <u>+</u> 0.03	0.45 <u>+</u> 0.05	0.27 <u>±</u> 0.02

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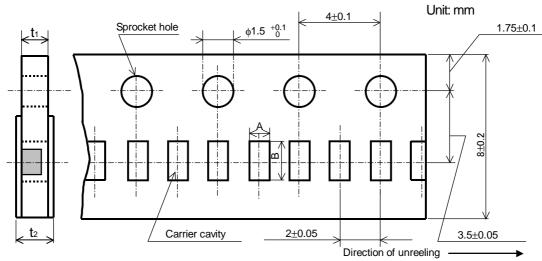
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8.2.2 Paper taping (8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-5 and Table-6.



		Figure–5		
		Table-6		Unit: mm
Style	A	В	t 1	t 2
RMPC10	0.65 ^{+0.05} -0.10	1.15 ^{+0.05} _{-0.10}	0.4 ± 0.05	0.5max.

8.2.3 Paper taping (8mm width, 4mm pitches)

Taping dimensions shall be in accordance with Figure-6 and Table-7.

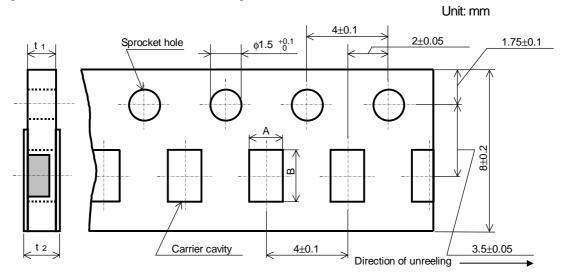


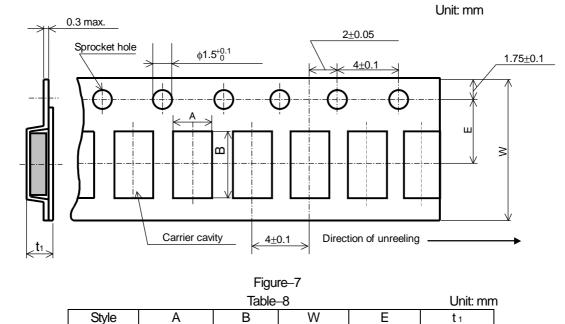
Figure-6

	0			
Table-7				
A	В	t 1	t 2	
1.15±0.15	1.9 ± 0.2	0.6 ± 0.1	0.8max.	
1.65±0.15	2.5±0.2	0.0.0.1	1.0000	
2.00±0.15	3.6 <u>+</u> 0.2	0.0±0.1	1.0max.	
	A 1.15±0.15 1.65±0.15	A B 1.15±0.15 1.9±0.2 1.65±0.15 2.5±0.2	A B t1 1.15±0.15 1.9±0.2 0.6±0.1 1.65±0.15 2.5±0.2 0.8±0.1	

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8.2.4 Embossed taping dimensions shall be in accordance with Figure-7 and Table-8.

1). The cover tapes shall not cover the sprocket holes.

RMPC35

- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following RMPC04,06: Figure–8, RMPC10,16,20,32: Figure–9, RMPC35: Figure–10.

3.5±0.2

6). When the tape is bent with the minimum radius for 25 mm the tape shall not be damaged and the components shall maintain their position and orientation in the tape.

8.0±0.2

3.5±0.05

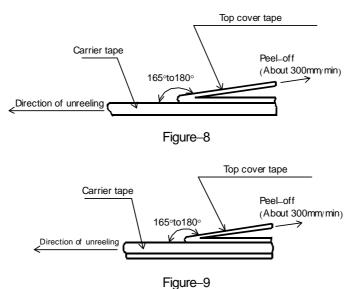
1.0±0.2

7). In no case shall there be two or more consecutive components missing.

The maximum number of missing components shall be one or 0.1%, whichever is greater.

8). The resistors shall be faced to upward at the over coating side in the carrier cavity.

2.85±0.20

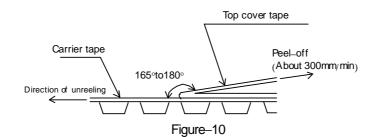


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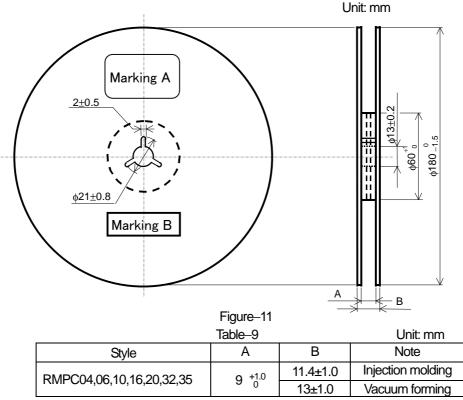
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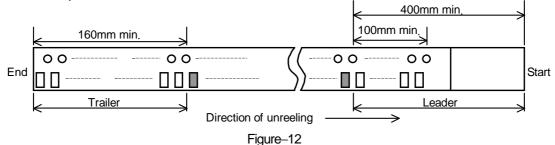
8.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure–11 and Table–9. Plastic reel (Based on EIAJ ET–7200C)



Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.

8.4 Leader and trailer tape.



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9. Marking on package

The label of a minimum package shall be legibly marked with follows.

9.1 Marking A

(1) Classification

(Style, Temperature coefficient of resistance, Rated resistance, Tolerance on rated resistance, Packaging form)

(2) Quantity (3) Lot number (4) Manufacturer's name or trade mark (5) Others

9.2 Marking B (KAMAYA Control label)

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